NOT RECOMMENDED FOR NEW DESIGN USE <u>DMP3036SFV</u>



DMP3008SFG

30V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} MAX	I _D MAX T _A = +25°C		
-30V	$17m\Omega$ @ $V_{GS} = -10V$	-8.6A		
	$25m\Omega$ @ $V_{GS} = -4.5V$	-7.1A		

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

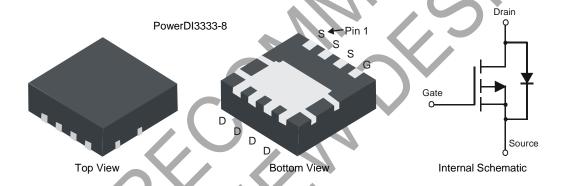
- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Low R_{DS(ON)} Ensures On State Losses are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)



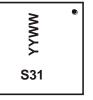
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3008SFG-7	PowerDI3333-8	2000/Tape & Reel
DMP3008SFG-13	PowerDI3333-8	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free. "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



S31 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)



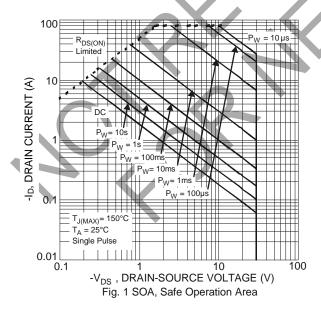
Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

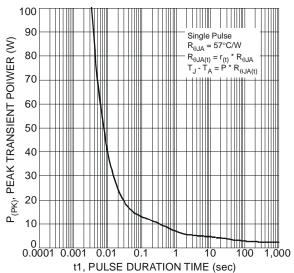
Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-30	V		
Gate-Source Voltage	V _{GSS}	±20	V		
0 11	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-8.6 -7.0	А
Continuous Drain Current (Note 6) V _{GS} = -10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-11.7 -9.3	Α
Continuous Drain Current (Note C) // 4.5/	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-7.1 -5.6	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-9.6 -7.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-80	Α		
Maximum Continuous Body Diode Forward Current (Note 6)			I _S	-3.0	А

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P _D	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D. C.	140	°C/W
Thermal Resistance, sunction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	72	°C/W
Total Power Dissipation (Note 6)		PD	2.2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State		57	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R_{θ} JA	30	°C/W
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	7.1	°C/W
Operating and Storage Temperature Range		T_{J} , T_{STG}	-55 to +150	°C

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

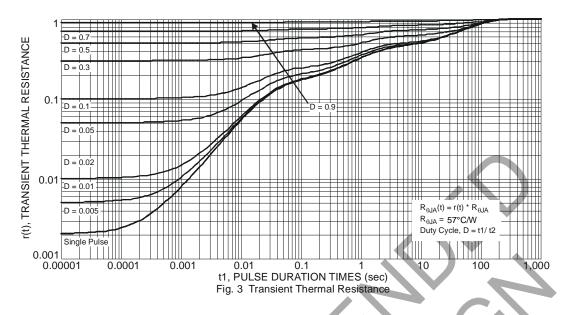




October 2017

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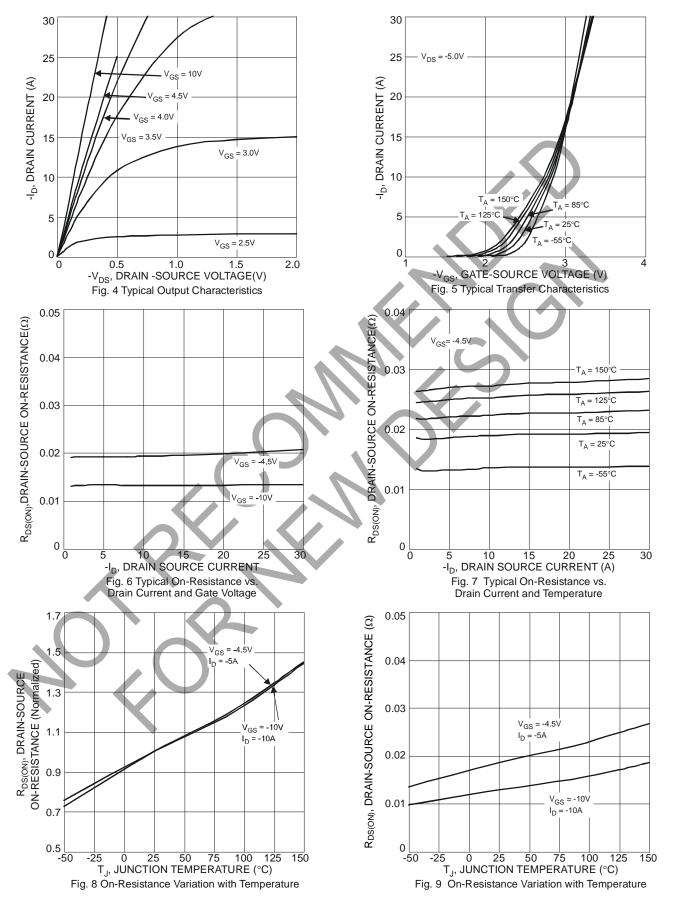


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

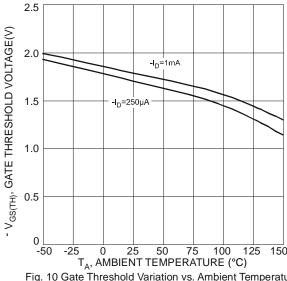
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage		-30	_	-	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		_	-1.0	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	Igss		1	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(TH)}$	4.1	-1.6	-2.1	>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance			12.5	17	mΩ	$V_{GS} = -10V, I_D = -10A$	
Static Dialif-Source Off-Nesistance	R _{DS(ON)}		18.5	25		$V_{GS} = -4.5V, I_D = -10A$	
Forward Transfer Admittance	Y _{fs}		13	_	S	$V_{DS} = -15V, I_{D} = -10A$	
Diode Forward Voltage	V _{SD}		-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		2230	_		45)/)/ 6)/	
Output Capacitance	Coss		328	_	$V_{DS} = -15V, V_{GS} = 0V$ f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	294	_		I = 1.0IVIHZ	
Gate Resistance	Rg	_	6.4	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = -10V)	Q_g		47	_			
Total Gate Charge (V _{GS} = -4.5V)	Q_g		23	_	nC	V 45V L 40A	
Gate-Source Charge	Q_{gs}	_	9.4	_	IIC	$V_{DS} = -15V, I_{D} = -10A$	
Gate-Drain Charge	Q_{gd}	_	5.6	_			
Turn-On Delay Time	t _{D(ON)}	_	10.5	_			
Turn-On Rise Time			8.5		20	$V_{GS} = -10V, V_{DS} = -15V, R_g = 6\Omega$	
Turn-Off Delay Time			90		ns		
rn-Off Fall Time t _F — 40 —							

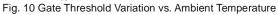
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

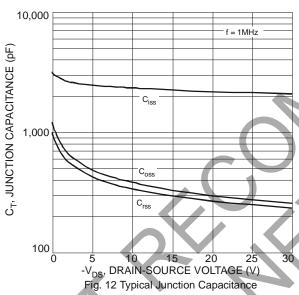


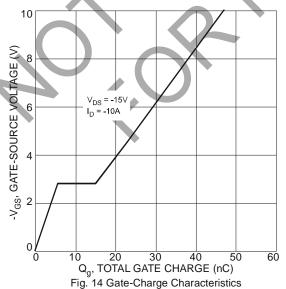


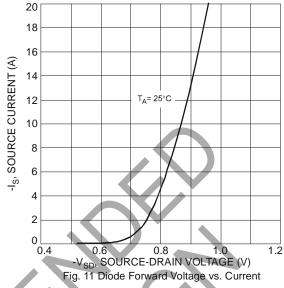












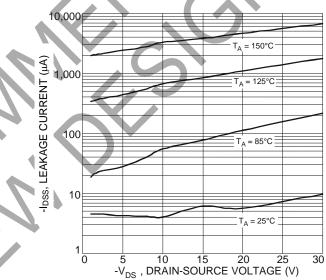


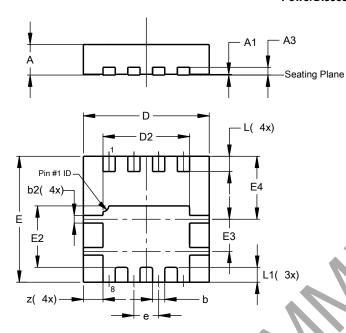
Fig. 13 Typical Drain-Source Leakage Current vs. Voltage



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

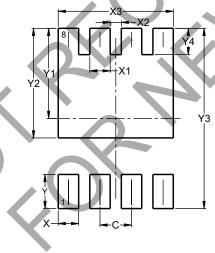


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A 1	0.00	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	-	_	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)		
С	0.650		
Χ	0.420		
X1	0.420		
X2	0.230		
Х3	2.370		
Y	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		
Y4	0.540		



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DMP3008SFG

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